User's Guide bq40z50EVM Li-Ion Battery Pack Manager Evaluation Module



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ABSTRACT

This evaluation module (EVM) is a complete evaluation system for the bq40z50 or bq296000 battery management system. The EVM includes one bq40z50 and bq296000 circuit module and a link to Microsoft[®] Windows[®] based PC software. The circuit module includes one bq40z50 integrated circuit (IC), one bq296000 IC, and all other onboard components necessary to monitor and predict capacity, perform cell balancing, monitor critical parameters, protect the cells from overcharge, over-discharge, short-circuit, and overcurrent in 1-, 2-, 3-, or 4-series cell Li-ion or Li-polymer battery packs. The circuit module connects directly across the cells in a battery. With the EV2300 or EV2400 interface board and software, the user can read the bq40z50 data registers, program the chipset for different pack configurations, log cycling data for further evaluation, and evaluate the overall functionality of the solution under different charge and discharge conditions.

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1 Features

- Complete evaluation system for the bq40z50EVM Li-Ion Battery Pack Manager Evaluation Module and bq296000 independent overvoltage protection IC
- Populated circuit module for quick setup
- Software that allows data logging for system analysis

1.1 Kit Contents

- bq40z50 and bq296000 circuit module
- Cable to connect the EVM to an EV2300 or EV2400 communications interface adapter

1.2 Ordering Information

For complete ordering information, see the product page at www.ti.com.

Table 1-1. Ordering Information EVM PART NUMBER CHEMISTRY CONFIGURATION CAPACITY bq40z50EVM-561 Li-ion 1-, 2-, 3-, or 4-cell Any

1.3 Documentation

See the device data sheets for bq40z50 and bq296000 and technical reference manuals (TRMs) on www.ti.com for information on device firmware and hardware.

1.4 bq40z50 and bq296000 Circuit Module Performance Specification Summary

This section summarizes the performance specifications of the bq40z50 and bq296000 EVM.

······································										
Specification	Minimum	Typical	Maximum	Units						
Input voltage Pack+ to Pack–	3	15	26	V						
Charge and discharge current	0	2	7	А						

Table 1-2. Performance Specification Summary



2 bq40z50EVM Quick Start Guide

This section provides the step-by-step procedures required to use a new EVM and configure it for operation in a laboratory environment.

2.1 Items Needed for EVM Setup and Evaluation

- bq40z50 or bq296000 circuit module
- EV2300 or EV2400 communications interface adapter
- Cable to connect the EVM to an EV2300 or EV2400 communications interface adapter
- · USB cable to connect the communications interface adapter to the computer
- Computer setup with Windows XP, or higher, operating system
- · Access to the Internet to download the Battery Management Studio software setup program
- One-to-four battery cells or $1-k\Omega$ resistors to configure a cell simulator
- A DC power supply that can supply 16.8 V and 2 A (constant current and constant voltage capability is desirable)

2.2 Software Installation

Find the latest software version in the bq40z50 tool folder on www.ti.com. Use the following steps to install the bq40z50 Battery Management Studio software:

- Download and run the Battery Management Studio setup program from the Development Tools section of the bq40z50EVM product folder on www.ti.com. See Section 3 for detailed information on using the tools in the Battery Management Studio.
- 2. If the communications interface adapter was not previously installed, after the Battery Management Studio installation, a TI USB driver installer pops up. Click "Yes" for the agreement message and follow its instructions. Two drivers are associated with the EV2300 and an additional file may be required for the EV2400. Follow the instructions to install both. Do not reboot the computer, even if asked to do so.
- 3. Plug the communications interface adapter into a USB port using the USB cable. The Windows system may show a prompt that new hardware has been found. When asked, "Can Windows connect to Windows Update to search for software?", select "No, not this time", and click "Next". In the next dialog window, it indicates "This wizard helps you install software for: TI USB Firmware Updater". Select "Install the software automatically (Recommended)" and click "Next". It is common for the next screen to be the Confirm File Replace screen. Click "No" to continue. If this screen does not appear, then go to the next step. After Windows indicates that the installation was finished, a similar dialog window pops up to install the second driver. Proceed with the same installation preference as the first one. The second driver is TI USB bq80xx Driver.

2.3 EVM Connections

This section covers the hardware connections for the EVM. See Figure 2-1.





• Direct connection to the cells: 1N (BAT-), 1P, 2P, 3P, 4P (BAT+)

Attach the cells to the J1 and J5 terminal block. A specific cell connection sequence is not required; although, it is good practice to start with lowest cell in the stack (cell 1), then attach cells 2 through 4 in sequence. The U1 and U2 devices should not be damaged by other cell connection sequences, but there is a possibility that the bq296000 could blow the fuse. Attaching cells starting with cell 1 should eliminate this risk. A short should be placed across unused voltage sense inputs. See Figure 2-2.

Number		J1 and J5 Terminal Block Connections							
of Cells	1N		1P		2P		3P		4P
1	\bigcirc	-cell1+	\bigcirc	short	\bigcirc	short	\bigcirc	short	\bigcirc
2	\bigcirc	-cell1+	\bigcirc	-cell2+	\bigcirc	short	\bigcirc	short	\bigcirc
3	\bigcirc	-cell1+	\bigcirc	-cell2+	\bigcirc	-cell3+	\bigcirc	short	\bigcirc
4	\bigcirc	-cell1+	\bigcirc	-cell2+	\bigcirc	-cell3+	\bigcirc	-cell4+	\bigcirc

Figure	2-2.	Cell	Connection	Configuration
--------	------	------	------------	---------------

A resistor cell simulator can be used instead of battery cells. Connect a resistor between each of the contacts on the J1 or J5 connector. For example, from 1N to 1P, from 1P to 2P, and so forth, until the desired number of cells has been achieved. A power supply can provide power to the cell simulator. Set the power supply to the desired cell voltage × the number of cells and attach the ground wire to 1N and the positive wire to 4P. For example, for a 3S configuration with a 3.6-V cell voltage, set the power supply to $3 \times 3.6 = 10.8$ V.

• Serial communications port (SMBC, SMBD)

Attach the communications interface adapter cable to J2 and to the SMB port on the EV2300.

• System load and charger connections across PACK+ and PACK-

Attach the load or power supply to the J3 or J4 terminal block. The positive load or power supply wire should be connected to at least one of the first two terminal block positions labeled PACK+. The ground wire for the load or power supply should be connected to the last terminal block positions labeled PACK–.

• System-present pin (SYS PRES)

To start charge or discharge test, connect the SYS PRES position on the J3 terminal block to PACK–. The SYS PRES can be left open if the non-removable (NR) bit is set to 1 in the Pack Configuration A register. To test sleep mode, disconnect the SYS PRES pin.

• Wake-up the device up from shutdown (WAKE)

Press the Wake pushbutton switch to temporarily connect Bat+ to Pack+. This applies voltage to the PACK pin on the bq40z50 to power-up the regulators and start the initialization sequence.

· Parameter setup

The default data flash settings configure the device for 3-series Li-Ion cells. The user should change the | Data Flash | Settings | DA Configuration register to set up the number of series cells to match the physical pack configuration. This provides basic functionality to the setup. Other data flash parameters should also be updated to fine tune the gauge to the pack. See the bq40z50 TRM for help with setting the parameters.

2.4 Update Firmware

Find the latest firmware version in the appropriate bq40z50 folder on www.ti.com. Use the following steps to install the bq40z50 *Battery Management Studio* software:

- 1. Run *Battery Management Studio* from the **Start | Programs | Texas Instruments | Battery Management Studio** menu sequence, or the *Battery Management Studio* shortcut.
- 2. Follow the directions in Section 3.5, select the firmware .srec file downloaded from www.ti.com, and click the **Program** button.
- 3. Once programming is finished, the EVM is ready to use with the latest firmware.

3 Battery Management Studio

3.1 Registers Screen

Run Battery Management Studio from the Start | Programs | Texas Instruments | Battery Management Studio menu sequence, or the Battery Management Studio shortcut. The Registers screen (see Figure 3-1) appears. The Registers section contains parameters used to monitor gauging. The Bit Registers section provides bit level picture of status and fault registers. A green flag indicates that the bit is 0 (low state) and a red flag indicates that the bit is 1 (high state). Data begins to appear once the *Refresh* (single-time scan) button is selected, or it scans continuously if the *Scan* button is selected.

egisters																	Label here.	. M) Scan	2 Refres
egisters																				
Name					Value	Uni	ts I	.og	Scan	Nam	e				Value		Units	Log	Scar	1
Manufacturer	Access				0x6181	he	x	•			It Full Cho	E			2523		cWH			H
Remaining Cap	. Alarm				300	mA	h	•	•	- T	rue Rem (2			-580		mAh		•	
Remaining Tim	e Alarm				10	mir	1	•			rue Rem B				-522		cWh		•	
🖌 At Rate					0	m/	(11) I.S.	•		- I	nitial Q				2818		mAh		V	
🗎 At Rate Time T	To Full				65535	mir	1			a 1	nitial E				3045		cWh			
🗏 At Rate Time T	To Empty	1			65535	mir	1	✓		⊺	rue Full C	hg Q			2238		mAh		•	
At Rate OK					1						rue Full C	hg E			2523		cWh		•	
Temperature					22.7	deg	С				_sim				23.4		degC			
I Voltane					11166	ml	1				amhiant				77 7		denC			
t Registers																				
Vame	Value	Log	s	Bit15	Bit14	Bit13	Bit12	Bit11	Bit10	Bit9	Bit8	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
Manufacturi	0x			CAL	LT	RSVD	RSVD	RSVD	RSVD	LED	FUS	BBR	PF_EN	LF_EN	FET	GAU	DSG	CHG	PCH	
Safety Alert	0x			RSVD	CUVC	OTD	OTC	ASCDL	RSVD	ASCCL	RSVD	AOLDL	RSVD	OCD2	OCD1	OCC2	OCC1	COV	CUV	
Safety Stat	0x			RSVD	CUVC	OTD	OTC	ASCDL	ASCD	ASCCL	ASCC	AOLDL	AOLD	OCD2	OCD1	OCC2	OCC1	COV	CUV	
Safety Alert	0x	~		RSVD	RSVD	RSVD	RSVD	UTD	UTC	PCHGC	CHGV	CHGC	OC	CTOS	RSVD	PTOS	RSVD	RSVD	OTF	
Safety Stat	0x			RSVD	RSVD	RSVD	RSVD	UTD	UTC .	PCHGC	CHGV	CHGC	OC	RSVD	СТО	RSVD	PTO	HWDF	OTF	-
PF Alert A +B	0x	¥		RSVD	RSVD	RSVD	VIMA	VIMR	CD	IMP	CB	QIM	SOTE	RSVD	SOT	SOCD	SOCC.	SOV	SUV	
PF Status A+B	0x		V	RSVD	RSVD	RSVD	VIMA	VIMR	CD	IMP	CB	QIM	SOTE	RSVD	SOT	SOCD	SOCC	SOV	SUV	
PF Alert C+D	0x			TS4	TS3	TS2	TS1	RSVD	RSVD	OPN	RSVD	RSVD	2LVL	AFEC	AFER	FUSE	RSVD	DFETF	CFETF	
PF Status C+D	0x		M	TS4	TS3	TS2	TS1	RSVD	DFW	OPN	IFC	PTC	2LVL	AFEC	AFER	FUSE	RSVD	DFETF	CFETF	
LStatus	0	~	V			-	2- 10	-					-		-	FIEL	ITEN	CF1	CF0	

Figure 3-1. Registers Screen

The continuous scanning period can be set via the | Window | Preferences | SBS | Scan Interval | menu selections.

The Battery Management Studio program provides a logging function which logs the values that are selected by the Log check boxes located beside each parameter in the Register section. To enable this function, select the *Log* button; this causes the *Scan* button to be selected. When logging is stopped, the *Scan* button is still selected and has to be manually deselected.

3.2 Setting Programmable bq40z50 Options

The bq40z50 data flash comes configured per the default settings detailed in the bq40z50 TRM. Ensure that the settings are correctly changed to match the pack and application for the solution being evaluated.

Note

The correct setting of these options is essential to get the best performance. The settings can be configured using the Data Flash screen (see Figure 3-2).



Data Flash 🕅									- 6
ata Flash		Filter/Search H	ex Dump Auto Export	t Export Impo	rt Write_All Re	∂ ead All			
ead/Write Data Flash Contents									
Calibration	Name	Value	Unit	Physical Start Ad	Data Length	Row Number	Row Offset	Native Units	-
	⊿ Voltage								
Settings	Cell Gain	12083		0x4000	2	0	0	-	
Destantions	Pack Gain	49173	-	0x4002	2	0	2	-	
Protections	BAT Gain	48867	12	0x4004	2	0	4	-	
Permanent Fail	Current								
	CC Gain	1.036	mOhm	0x4006	4	0	6	-	
Advanced Charge Algorithm	Capacity Gain	1.036	mOhm	0x400a	4	0	10	-	E
Cas Causian	Current Offset								
Gas Gauging	CC Offset	0	1.71	0x400e	2	0	14	-	
Power	Coulomb Counter Offset Samples	64		0x4010	2	0	16		
	Board Offset	0	-	0x4012	2	0	18	-	
PF Status	CC Auto Config	03	hex	0x40c0	1	6	0	hex	
Sustana Data	CC Auto Offset	0	-	0x40c1	2	6	1	-	
System Data	⊿ Temperature								<u> </u>
SBS Configuration	Internal Temp Offset	4.2	degC	0x4014	1	0	20	0.1degC	
	External1 Temp Offset	1.5	degC	0x4015	1	0	21	0.1degC	
LED Support	External2 Temp Offset	1.7	degC	0x4016	1	0	22	0.1degC	
Rinels Rev	External3 Temp Offset	1.9	degC	0x4017	1	0	23	0.1degC	
DIACK DOX	External4 Temp Offset	1.5	degC	0x4018	1	0	24	0.1degC	
Lifetimes	Internal Temp Model								
	Int Gain	-12143	-	0x45c0	2	46	0	-	
Ra Table	Int base offset	6232	(. =)	0x45c2	2	46	2	-	
	Int Minimum AD	0		0x45c4	2	46	4		
	Int Maximum Temp	6232	0.1degK	0x45c6	2	46	6	0.1degK	
	Cell Temperature Model								
	Coeff a1	-11130		0x45c8	2	46	8		
	Coeff a2	19142	-	0x45ca	2	46	10	-	
	Coeff a3	-19262	121	0x45cc	2	46	12	2	-

Figure 3-2. Data Flash Screen

3.3 Calibration Screen

The voltages, temperatures, and currents should be calibrated to provide good gauging performance.

Press the Calibration button to select the Advanced Calibration window. See Figure 3-3.

Calibration 🛛		- 0)
Advanced Calibration		
Perform Calibration		
Select the types of calibration to perform and enter the actual input param	eters in the corresponding boxes	
Applied Current	Sensor Applied temperature Calibrate	
mA 🗖 Calibrate Current	Internal deg C 🗖	
	External 1 deg C	
Voltage calibration	External 2 deg C 🗖	
Applied Cell 1 voltage		
mv 🗖 Calibrate Voltage	Calibrate Gas Gauge	
Applied Battery Voltage		
my Calibrate Battery voltage		

Figure 3-3. Calibration Screen

3.3.1 Voltage Calibration

 Measure the voltage from Cell 1 to 1N and enter this value in the Applied Cell 1 Voltage field and select the Calibrate Voltage box.



- Measure the voltage from Bat+ to Bat– and enter this value in the Applied Battery Voltage field and select the Calibrate Battery Voltage box.
- Measure the voltage from Pack+ to Pack– and enter this value in the Applied Pack Voltage field and select the Calibrate Pack Voltage box. If the voltage is not present, then turn the charge and discharge FETs on by entering a 0x0022 command in the Manufacturer Access register on the Register screen.
- Press the Calibrate Gas Gauge button to calibrate the voltage measurement system.
- Deselect the Calibrate Voltage boxes after voltage calibration has completed.

3.3.2 Temperature Calibration

- Enter the room temperature in each of the Applied Temperature fields and select the Calibrate box for each thermistor to be calibrated. The temperature values must be entered in degrees Celsius.
- Press the Calibrate Gas Gauge button to calibrate the temperature measurement system.
- Deselect the Calibrate boxes after temperature calibration has completed.

3.3.3 Current Calibration

The Board Offset calibration option is not offered in Battery Management Studio, because it is not required when using the bq40z50EVM. The Board Offset calibration option is available in bqProduction.

- Connect and measure a 2-A current source from 1N (–) and Pack– (+) to calibrate without using the FETs. (TI does not recommend calibration using the FETs.)
- Enter –2000 in the Applied Current field and select the Calibrate Current box.
- Press the Calibrate Gas Gauge button to calibrate.
- Deselect the Calibrate Current box after current calibration has completed.

Note

Current can also be calibrated using the FETs. Measure the current in the discharge path and enter this value in the Applied Current field.



3.4 Chemistry Screen

The chemistry file contains parameters that the simulations use to model the cell and its operating profile. It is critical to program a Chemistry ID that matches the cell into the device. Some of these parameters can be viewed in the Data Flash section of the Battery Management Studio.

Press the *Chemistry* button to select the Chemistry window.

Model	Chemistry ID	Description	
LGR18650OU	0100	LiCoO2/graphitized carbon (default)	
ALPBA002 (3430mAh)	0207	NiCoMn/carbon 2	
ANR26650M1-B (2500mAh)	0440	LiFePO4/carbon	
26650A	0400	LiFePO4/carbon	
APR18650M1 (1100 mAh)	0404	LiFePO4/carbon	
LFP-18650-1500 (1500 mAh)	0439	LiFePO4/carbon	
AE1004765 (3500mAh)	0131	LiCoO2/carbon 4	
AE583696PM1HR (2150 mAh)	0222	PSS, LiNiO2 with Co, Mn doping	
TP2000-1SPL (2000mAh)	0190	LiCoO2/carbon 11	
INR34600K2 (7500mAh)	0210	NiCoMn/carbon	
26700FE (3300mAh)	0411	LiFePO4/carbon	
A2770102 (13000mAh)	0412	LiFePO4/carbon	
LPC 776285M	0204	NiCoMn/carbon	
LPC5099130L (5120 mAh)	0304	NiCoMn/carbon, 4.2V	
LPC776825I (2700 mAh)	0304	NiCoMn/carbon, 4.2V	
	Model LGR186500U ALPBA002 (3430mAh) ANR26650M1-B (2500mAh) 26650A APR18650M1 (1100 mAh) LFP-18650-1500 (1500 mAh) AE1004765 (3500mAh) AE583696PM1HR (2150 mAh) TP2000-1SPL (2000mAh) JNR34600K2 (7500mAh) 26700FE (3300mAh) A2770102 (13000mAh) LPC 776285M LPC5099130L (5120 mAh) LPC5776825I (2700 mAh)	Model Chemistry ID LGR186500U 0100 ALPBA002 (3430mAh) 0207 ANR26650M1-B (2500mAh) 0440 26650A 0400 APR18650M1 (1100 mAh) 0404 LFP-18650-1500 (1500 mAh) 0439 AE1004765 (3500mAh) 0131 AE583696PM1HR (2150 mAh) 0222 TP2000-1SPL (2000mAh) 0190 INR34600K2 (7500mAh) 0210 26700FE (3300mAh) 0411 A2770102 (1300mAh) 0412 LPC 776285M 0204 LPC5099130L (5120 mAh) 0304	Model Chemistry ID Description LGR18650OU 0100 LiCoO2/graphitized carbon (default) ALPBA002 (3430mAh) 0207 NiCoMn/carbon 2 ANR26650M1-B (2500mAh) 0440 LiFePO4/carbon 2650A 0400 LiFePO4/carbon APR1865011 (1100 mAh) 0404 LiFePO4/carbon LFP-18650-1500 (1500 mAh) 0439 LiFePO4/carbon AFR18650150 (1500 mAh) 0439 LiFePO4/carbon AFS3696PM1HR (2150 mAh) 0439 LiFePO4/carbon AFS3696PM1HR (2150 mAh) 0131 LiCoO2/carbon 4 AES83696PM1HR (2150 mAh) 0222 PSS, LiNiO2 with Co, Mn doping TP2000-1SPL (2000mAh) 0190 LiCoO2/carbon 11 INR34600K2 (7500mAh) 0210 NicoMn/carbon 26700FE (3300mAh) 0210 NicoMn/carbon 26700FE (3300mAh) 0411 LiFePO4/carbon A2770102 (13000mAh) 0412 LiFePO4/carbon A2770102 (13000mAh) 0412 LiFePO4/carbon LPC 776285M 0204 NiCoMn/carbon LPC5099130L (5120 mA

Figure 3-4. Chemistry Screen

- The table can be sorted by clicking the desired column. for example: Click the Chemistry ID column header.
- Select the ChemID that matches your cell from the table (see Figure 3-4).
- Press the Update Chemistry in the Data Flash button to update the chemistry in the device.



3.5 Firmware Screen

Press the *Firmware* button to select the Firmware Update window. This window allows the user to export and import the device firmware.

🗒 Firmware 🛛	
Firmware Update	
Firmware Update	
F/W Programming	
Program C:\bq40z50_v0_11_build_23.srec Brow	e
Execute after programming Execute	e
Read Srec C:\bq40z50_test.srec Brow	e
L	

Figure 3-5. Firmware Screen

3.5.1 Programming the Flash Memory

The upper section of the Firmware screen is used to initialize the device by loading the default .srec into the flash memory (see Figure 3-5).

- Search for the .srec file using the *Browse* button.
- Select the *Execute after programming* box to automatically return the device to Normal mode after programming has completed.
- · Press the Program button and wait for the download to complete.

3.5.2 Exporting the Flash Memory

The lower section of the Firmware screen is used to export all of the flash memory from the device (see Figure 3-5).

- Press the Browse button and enter an .srec filename.
- Press the *Read Srec* to save the flash memory contents to the file. Wait for the download to complete.



3.6 Advanced Comm SMB Screen

Press the *Advanced Comm SMB* button to select the Advanced SMB Comm window. This tool provides access to parameters using SMB and Manufacturing Access commands. See Figure 3-6.

Advanced Comm SMB 🖾			
dvanced Comm SMB			
dvanced Comm			
Config			
Protocol SMB +	Target Address 17 (Hex) (23 Dec)	
Word Read/Write Command	Word	Туре	
Send Cmd (Hex) (Dec)		Hex 💌	
Read Word (Hex) (Dec)	0x		
Write Word (Hex) (Dec)	0x		
Block Read/Write	Block	Туре	
Read Block (Hex) (Dec)	0x	Hex -	
Write Block (Hex) (Dec)	0x		
		-	
	ASCII		

Figure 3-6. Advanced Comm Screen

Examples:

Reading an SMB Command.

- Read SBData Voltage (0x09)
 - SMBus Read Word. Command = 0x09
 - Word = 0x3A7B, which is hexadecimal for 14971 mV

Sending a MAC Gauging() to enable IT via ManufacturerAccess().

- With Impedance Track[™] disabled, send Gauging() (0x0021) to ManufacturerAccess().
 - SMBus Write Word. Command = 0x00. Data = 00 21

Reading Chemical ID() (0x0006) via ManufacturerAccess()

- Send Chemical ID() to ManufacturerAccess()
 - SMBus Write Word. Command = 0x00. Data sent = 00 06
- Read the result from ManufacturerData()
 - SMBus Read Block. Command = 0x23. Data read = 00 01
 - That is 0x0100, chem ID 100



4 bq40z50EVM Circuit Module Schematic

This section contains information on modifying the EVM and using various features on the reference design.

4.1 Pre-Charge

The EVM provides a power resistor and FET to support a reduced current pre-charge path to charge the pack when cell voltages are below the pre-charge voltage threshold. This reduces heating that could lead to cell damage or reduced operating lifetime. The resistor (R1) is set up to limit the current to less than 40 mA for a 4S configuration. The user can change R1 to setup the pre-charge current to a different value.

4.2 LED Control

The EVM is configured to support five LEDs to provide state-of-charge information for the cells. The LED interface is enabled by entering a 0x0027 command in the Manufacturing Access register on the Registers screen. Press the *LED DISPLAY* button to illuminate the LEDs for approximately 5 seconds.

4.3 Emergency Shutdown

The Emergency Shutdown function allows the user to disable the charge and discharge FETs with an external GPIO pin. The EMSHUT and NR bits must be set high in the DA Configuration register to enable this feature. Press the SHUTDOWN pushbutton switch for one second to disable these FETs, and press it again for one second to enable them.

Note	

Remember to remove the SYS PRES-to-PACK- short, if present.

4.4 Testing Fuse-Blowing Circuit

To prevent the loss of board functionality during the fuse-blowing test, the actual chemical fuse is not provided on the EVM. FET Q5 drives the FUSE test point low if a fuse-blow condition occurs. FUSE is attached to an open drain FET, so a pull-up resistor is required to check whether the FUSE pulls low. A FUSEPIN test point is attached to the gate of Q5; so, monitoring FUSEPIN can be used to test this condition without adding a pull-up resistor. Fuse placement on the application board is shown in the bq40z50 data sheet. A chemical fuse can also be soldered to the EVM for in-system testing. A copper bridge is included on the PCB to bypass the chemical fuse, so it has to be cut to allow the fuse to open the power path. The cut is illustrated in yellow on Figure 4-1 with arrows pointing to the location.



Top Layer

Bottom Layer





4.5 PTC Thermistor

The PTC interface is designed to work with a specific PTC thermistor. The thermistor must have a 10-k Ω typical resistance over the normal operating temperature range and the resistance must be greater than 1.2 M Ω at the PTC trip temperature. The muRata PRF18BA103QB1RB thermistor will work with this device.

The EVM has a 10-k Ω resistor installed on the PTC footprint.

The PTC function can be disabled by connecting PTC and PTCEN to VSS.

5 Circuit Module Physical Layouts

This section contains the printed-circuit board (PCB) layout, assembly drawings, and schematic for the bq40z50 and bq296000 circuit modules.

5.1 Board Layout

This section shows the dimensions, PCB layers, and assembly drawing for the bq40z50 modules.



Figure 5-1. Top Silk Screen



Figure 5-2. Bottom Silk Screen





Figure 5-3. Top Assembly



Figure 5-4. Bottom Assembly



Figure 5-5. Top Layer





Figure 5-6. Internal Layer 1



Figure 5-7. Internal Layer 2



Figure 5-8. Bottom Layer

5.2 Schematic



6 Bill of Materials

COUNT	RefDes	Value	Description	Size	Part Number	MFR
16	C1-6, C8-12, C14-18	0.1 µF	Capacitor, Ceramic Chip, 50 V, X7R, 20%	0603	C0603C104M5RACTU	Kemet
1	C7	0.47 µF	Capacitor, Ceramic, 0.47 μF, 10 V, X5R, 10%	0603	C0603C474K8PACTU	Kemet
1	C13	2.2 µF	Capacitor, Ceramic, 25 V, X7R, 20%	0805	C2012X7R1E225M085AB	TDK
0	C19-21	DNP	Capacitor, Ceramic, 50 V, X7R, 20%	0603	C0603C104M5RACTU	Kemet
1	D1	BAT54HT1G	Diode, Schottky, 200-mA, 30-V	SOD323	BAT54HT1G	On Semi
3	D2-4	MM3Z5V6C	Diode, Zener, 5.6V, 200mW	SOD323	MM3Z5V6C	Fairchild
5	D5-9	SML-X23GC	LED 2x3mm 565nm GRN WTR CLR SMD	1206	SML-X23GC	Lumex
0	F1	DNP	Fuse, Slo-Blo Ceramic, xxA, yyyV	SFDxxx	SFDxxxx	Sony
1	R1	300	Resistor, Chip, 1W, 5%	2512	CRCW2512300RJNEG	Vishay-Dale
3	R2-3, R5	10M	Resistor, Chip, 1/10-W, 5%	0603	CRCW060310M0JNEA	Vishay-Dale
3	R4, R12, R32	10K	Resistor, Chip, 1/10-W, 5%	0603	CRCW060310K0JNEA	Vishay-Dale
1	R6	51K	Resistor, Chip, 1/16-W, 5%	0603	CRCW060351K0JNEA	Vishay-Dale
5	R7-8, R10, R16-17	5.1K	Resistor, Chip, 1/10-W, 5%	0603	CRCW06035K10JNEA	Vishay-Dale
10	R9, R11, R20-23, R25, R27, R30-31	100	Resistor, Chip, 1/10-W, 5%	0603	CRCW0603100RJNEAHP	Vishay-Dale
5	R13-15 R18 R29	1K	Resistor, Chip, 1/10-W, 5%	0603	CRCW06031K00JNEA	Vishay-Dale
1	R19	0.001 50ppm	Resistor, Chip, 1 watt, ± 1%	1206	CSR1206-0R001F1	Riedon
3	R24, R26, R28	200	Resistor, Chip, 1/16-W, 5%	0603	CRCW0603200RJNEA	Vishay-Dale
1	R33	5.1	Resistor, 5.1, 0.063 W, 5%, 0402	0402	CRCW04025R10JNED	Vishay-Dale
2	J1, J4	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inch	ED555/2DS	OST
1	J2	22-05-3041	Header, Friction Lock Ass'y, 4-pin Right Angle,	0.400 x 0.500 inch	22-05-3041	Molex
2	J3, J5	ED555/3DS	Terminal Block, 3-pin, 6-A, 3.5mm	0.41 x 0.25 inch	ED555/3DS	OST
0	J6		Header, TH, 100mil spacing, 2x1, 230 mil above insulator	0.100 inch x 2	PEC02SAAN	Sullins
1	LBL1		Thermal Transfer Printable Labels, 1.250 W x 0.250 H inch - 10,000 per roll	PCB Label 1.250 W x 0.250 H inch	THT-13-457-10	Brady
1	RT1	10K	Thermistor, NTC, 5 Ω , 1-A	1206	CRCW120610K0JNEA	Vishay
4	RT2-5	10K	Thermistor, NTC, 3-A	0.095 X 0.150 inch	103AT-2	Semitec
3	S1, S2, S3	EVQ-PLHA15	Switch, Push button, Momentary, 1P1T, 50-mA, 12-V	0.200 x 0.200 inch	EVQ-PLHA15	Panasonic
1	TP3	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	Q1	FDN358P	MOSFET, Pch, -30V, -1.5A, 125 mΩ	SOT23	FDN358P	Fairchild
2	Q2-3	Si7114DN-T1-E3	MOSFET Nch 30V, 11.7A, 7.5 mΩ	PWRPAK 1212	Si7114DN-T1-E3	Vishay
1	Q4	2N7002K-T1-E3	MOSFET, Nch, 60V, 300 mA, 2-Ω	SOT23	2N7002K-T1-E3	Vishay
1	Q5	Si1414DH-T1-GE3	MOSFET, Nch, 30V, 4A, 46 mΩ	SC-70	Si1414DH-T1-GE3	Vishay
1	U1	BQ40Z50RSMR(T)- R1	IC, 2- to 4-Series Li-Ion Battery Pack Manager	QFN	BQ40Z50RSMR(T)-R1	TI
1	U2		IC, Overvoltage Protection for 2-Series, 3- Series, and 4-Series Cell Li-Ion Batteries with Regulated Output Supply, DSG0008A	DSG0008A	BQ296103DSGT	TI
1	W1		Cable assembly, 4 pin	N/A	CBL002	TI
1	IPCB		Printed Circuit Board	4.25 in x 1.25 in	PWR561	Any



7 Related Documentation from Texas Instruments

- bq40z50, 1-Series, 2-Series, 3-Series, and 4-Series Li-Ion Battery Pack Manager data sheet, SLUSBS8
- bq40z50 Technical Reference Manual, SLUUA43
- bq296000, BQ2960XY/BQ2961XY Overvoltage Protection for 2-Series, 3-Series, and 4-Series Cell Li-Ion Batteries with Regulated Output Supply, SLUSBU5

8 Revision History

Changes from Revision B (September 2016) to Revision C (November 2022)			
Updated the numbering format for tables, figures, and cross-references throughout the document.	1		
Changes from Revision A (July, 2015) to Revision B (September, 2016)			
Added Update Firmware section	5		

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